



| *Tencent* |

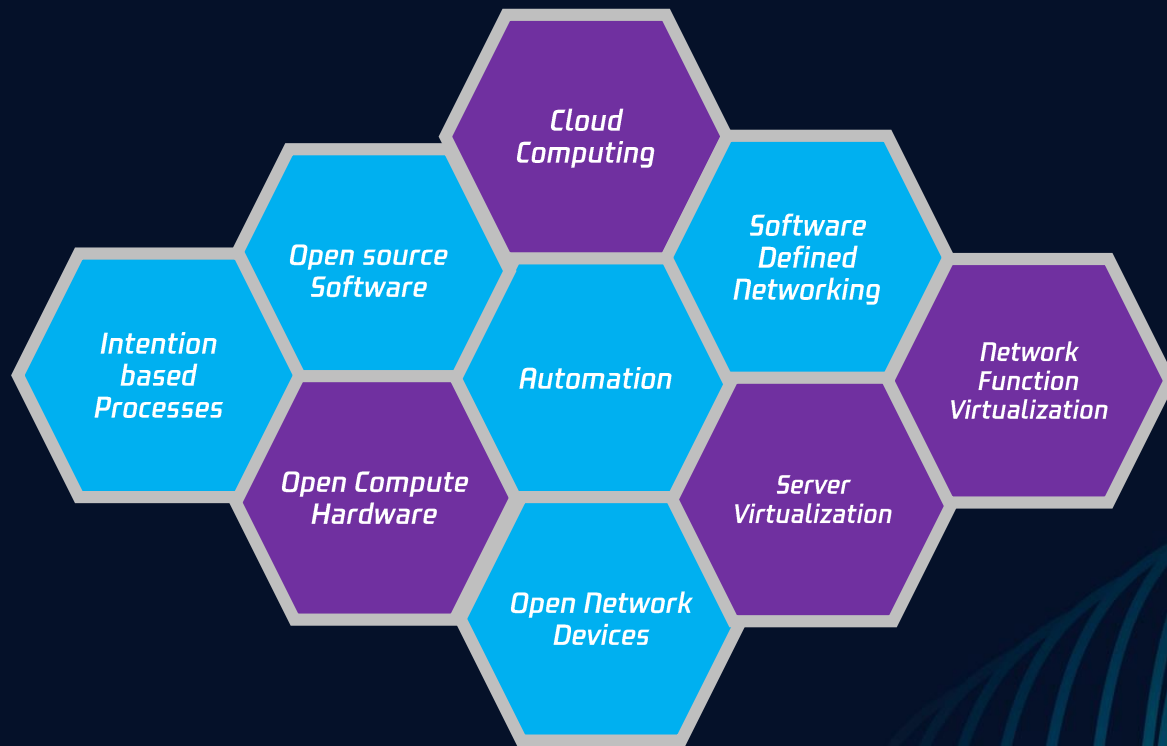
 Tencent Cloud

# *Open DCN networking*

*Andrew Qu*

*2019.01.15*

# >>> *Open Networking @ Tencent*



# >>> Open Networking Ecosystems @ Tencent

Open source  
Software

Software  
Defined  
Networking

Automation  
Intention based  
Processes  
Automation

Open Network  
Devices

Open/R

GoBGP

FRROUTING

BIRD

STRATUM

OPENDAYLIGHT

openstack.

P4

Co-  
development

RED HAT  
ANSIBLE

rConfig™  
NETWORK MANAGEMENT

Batfish

MiniNet

StarlingX

influxdb

Grafana

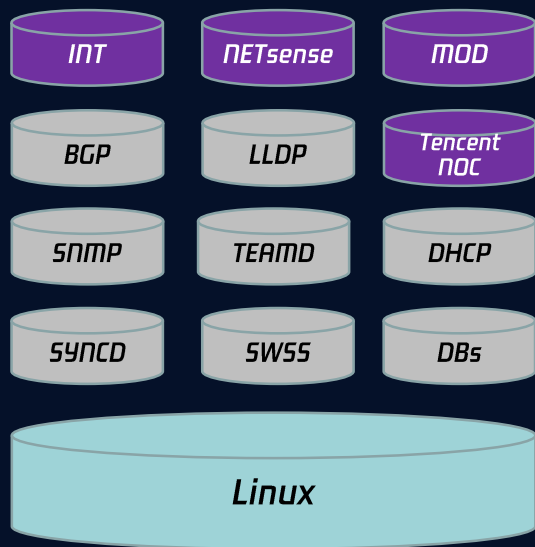
APACHE  
kafka

opendatacenter.cn

OPEN  
Compute Project®



# Tencent DCN Open NOS: SONiC

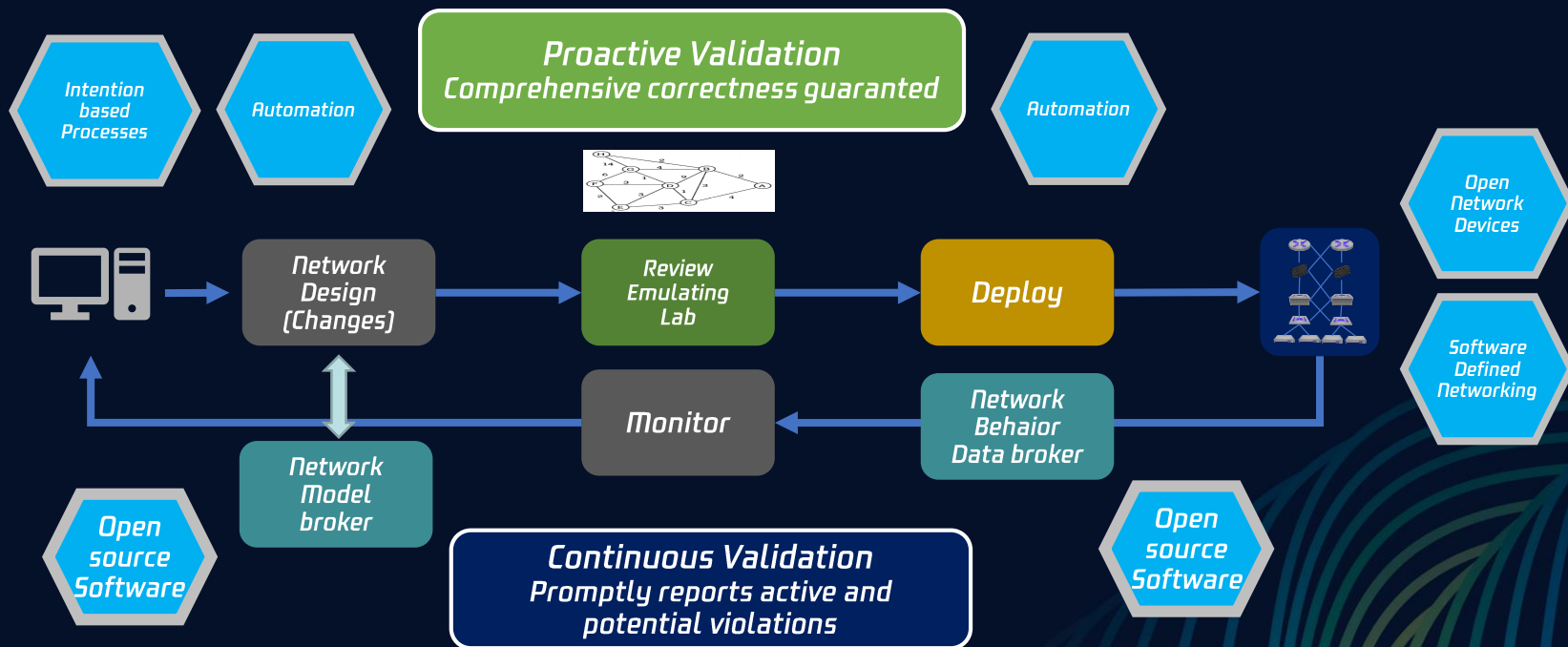


## Future SONiC enabled Fabric



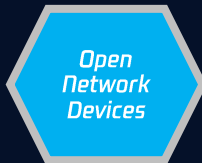
2019

# Tencent open DCN networking in making





## Tencent DCN Open Switches

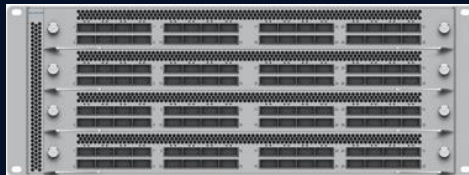
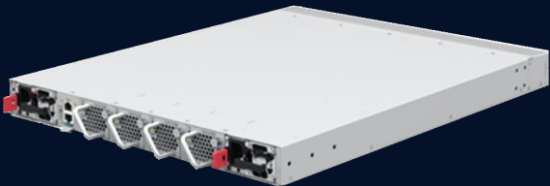


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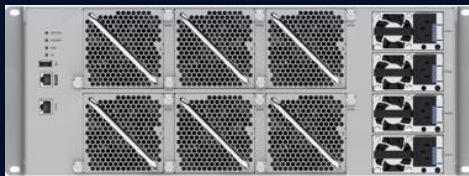
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- Front panel 48\*25G+8\*100G;
- 3+1 Fans, 1+1 PSUs;
- ASIC: BCM56873 (TD3)
- Selected Cage, PSU, FAN;
- Selected CPU: Intel D-1527;
- Dual: BIOS, Dual BMC image;
- Optical Module Init Process;
- I2C architecture,
- UART customization;



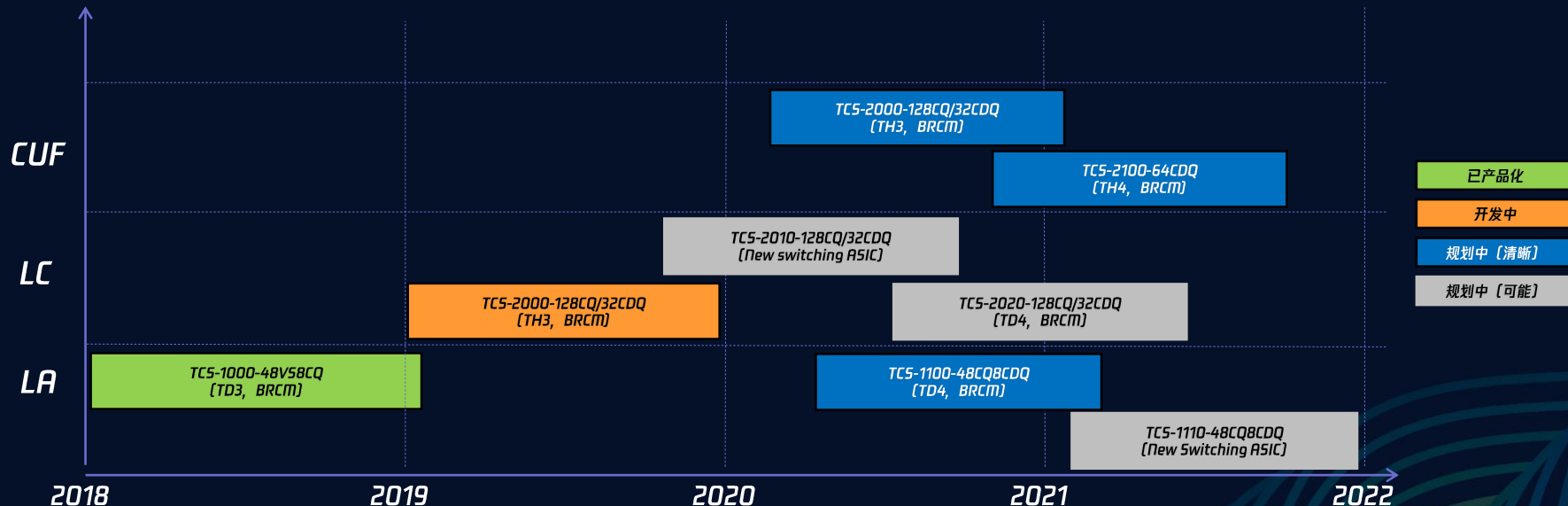
- 4U, Horizontal, Pluggable;
- 100G or 400G Line cards,
- 100G and 400G LCs ;
- 5+1 PSUs, 2+2 Fans;
- ASIC: BCM56980 (TH3)
- Trident4 considered;
- Selected Cage, PSU, FAN;
- CPU: Intel D-1527,
- Dual BIOS, Dual BMC image
- I2C architecture,
- UART customization





# Tencent DCN Switch roadmap

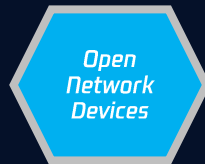
Open  
Network  
Devices



- LA/LC: Initial deployment in 2019, more afterwards



# Tencent DCN: Open Optical module



## ► Major problems

### ► Certification Process/Lab setup

#### Background checking

Stability in resource  
Historical shipment record  
Capacity in production  
Shipments  
System issue record

#### Module device analysis

DPA Analysis  
Module performance test  
Reliability  
Long fiber test

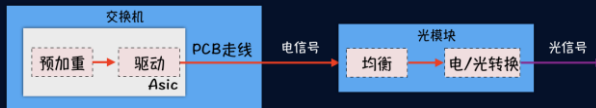
#### Interoperability

Between Vendors  
Long fiber test

Systems Test → EFT → MP

Under Designed situation;  
System tests;  
Stress tests with various factors;

### ► Interoperability

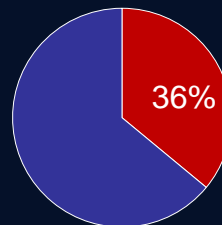


Risk in compatibility of high speed electrical signal:  
Between ASIC PHY and the Optical module, SERDES signal degradation via PCB could be severe, which causes jitter, hence the error in decoding

Other problems are like: System flaw in shipments, Switch hardware failure in shipments, Software patch caused issue, more specifically, these issues are hard to find in early testing cycle.

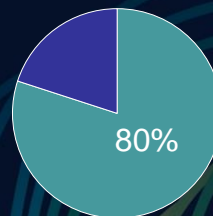
### ► Reliability

Tencent 现网故障统计



■ Module ■ Other

Tencent 光模块问题分类



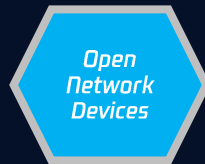
■ Laser ■ Others





# Tencent DCN: Open Optical module

-- Next Generation consideration

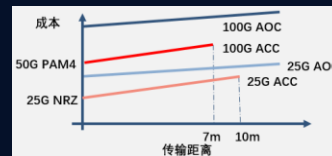
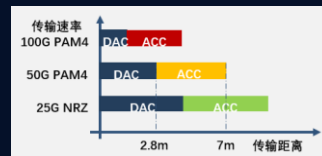


## ► Architecture evolution



## ► 100G/400G ODM Tencent spec Modules

✓ Low cost 100G ACC technology:



✓ Silicon Photonic 400G eDR4:



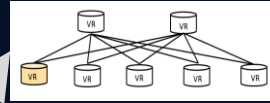


*THANKS*

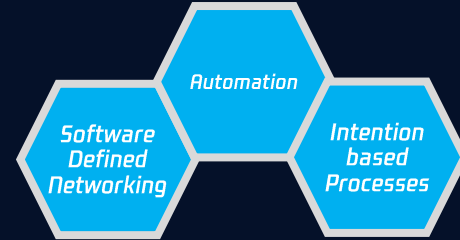
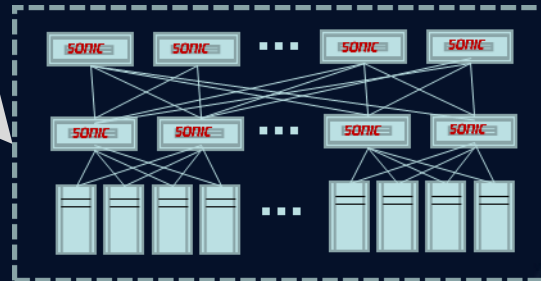
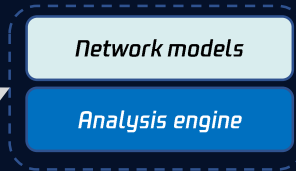
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## Network Emulator



## Network Policy Checker



### Certifications:

- All devices are password protected

### Violations:

- Subnets of Leaf-1 and Leaf-3 cannot communicate
- rtr-y failure reduces availability